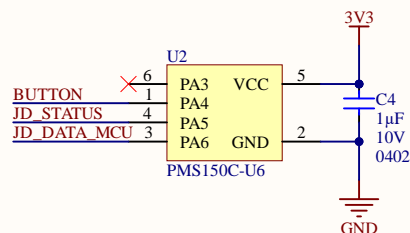
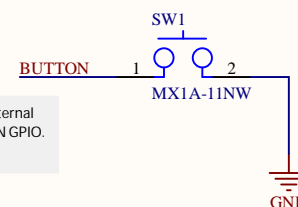


MCU



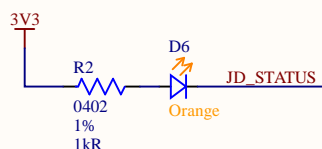
U2 must be programmed before being soldered down due to restrictive in-circuit programming requirements. JD_STATUS is PWM-capable GPIO.

Button



MCU must have internal pull-up on BUTTON GPIO.

Status LED



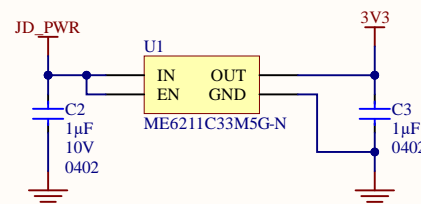
D6
Alternative part
SML-D12D
E6C0603SEAC1UDA
NCD0603O1

Jacdac modules require a status LED.

The LED can be monochrome or multicolor depending on GPIO availability

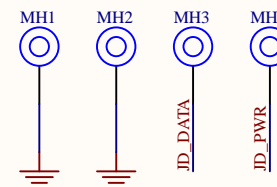
If using alternative part recalculate the resistor values R2

3V3 Regulator



U1 alternative parts:
ME6212C33M5G 6V 260mV @ 200mA Iout 350mA
NCP114BSN330T1G 5.5V 225mV @ 300mA Iout 300mA

Mounting holes



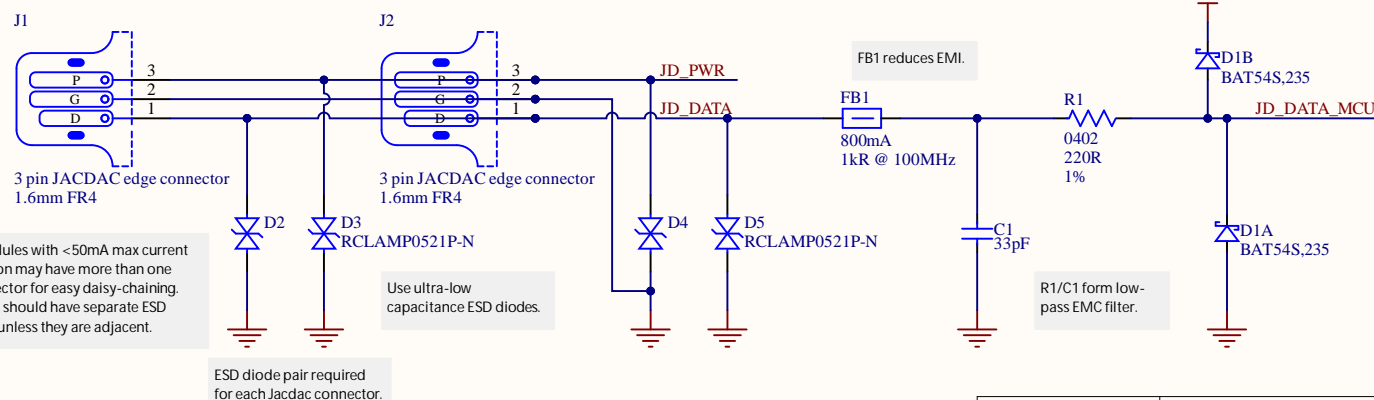
JACDAC mounting holes are plated through hole, finished diameter of 2.1mm, annular ring of 3.0mm diameter and copper/component keepout of 5.0mm. The mounting holes should be on 2.5mm pitch.

MH1 & MH2 : GND
MH3 : JD_DATA
MH4 : JD_PWR

Mounting holes should have appropriate silkscreen marker, and MH1 should have a pin 1 marker on the top side.

Jaccac modules require mounting holes. Modules mounting holes are electrically connected so that modules can be mounted on top of other PCBs without using cables.

Jacdac connector



Jaccad modules with <50mA max current consumption may have more than one edge connector for easy daisy-chaining. Connectors should have separate ESD protection unless they are adjacent.

Use ultra-low capacitance ESD diodes.

ESD diode pair required
for each Jaccard connector.

D1 clamps JD_DATA to protect MCU.

FB1 reduces EMI.

FB1
800mA
1kR @ 100MHz

R1/C1 form low-pass EMC filter.

R1
0402
220R

3V3
D1B
BAT54S.235

R1
0402
220R

Microsoft

PROJECT DESCRIPTION

SHEET DESCRIPTION
Complete design

PROJECTFILENAME JacdacKeyboardKey 46.PrjPCB

PROJECT CODENAME JacdacKeyboardKey

LAST MODIFIED 10/11/2021 | PAGE 1 OF 1

SHEET FILENAME JacdacKeyboardKey 46.SchDoc

LICENCE [Attribution 4.0 International \(CC BY 4.0\)](#)

REVISION 1.3 PCB ID 46-1.3

When this PDF is viewed with Adobe Reader, clicking on components shows part numbers and other details.

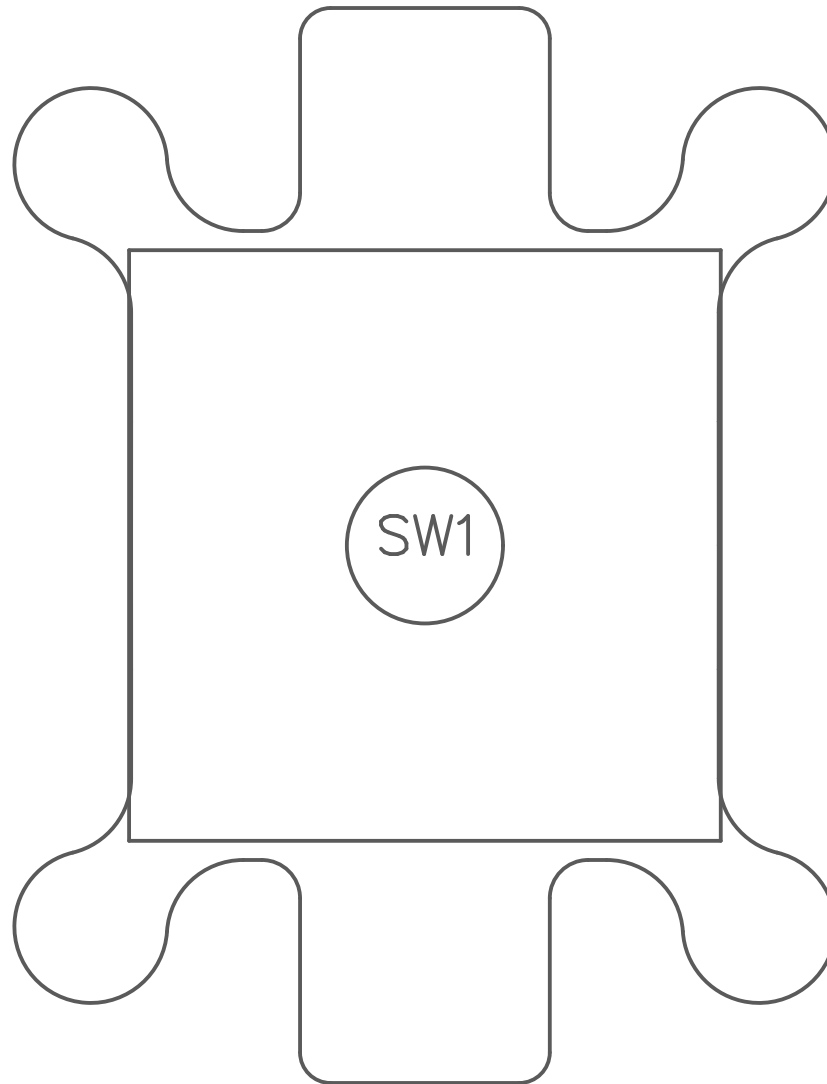
Silkscreen & layout notes

Block name

Design notes

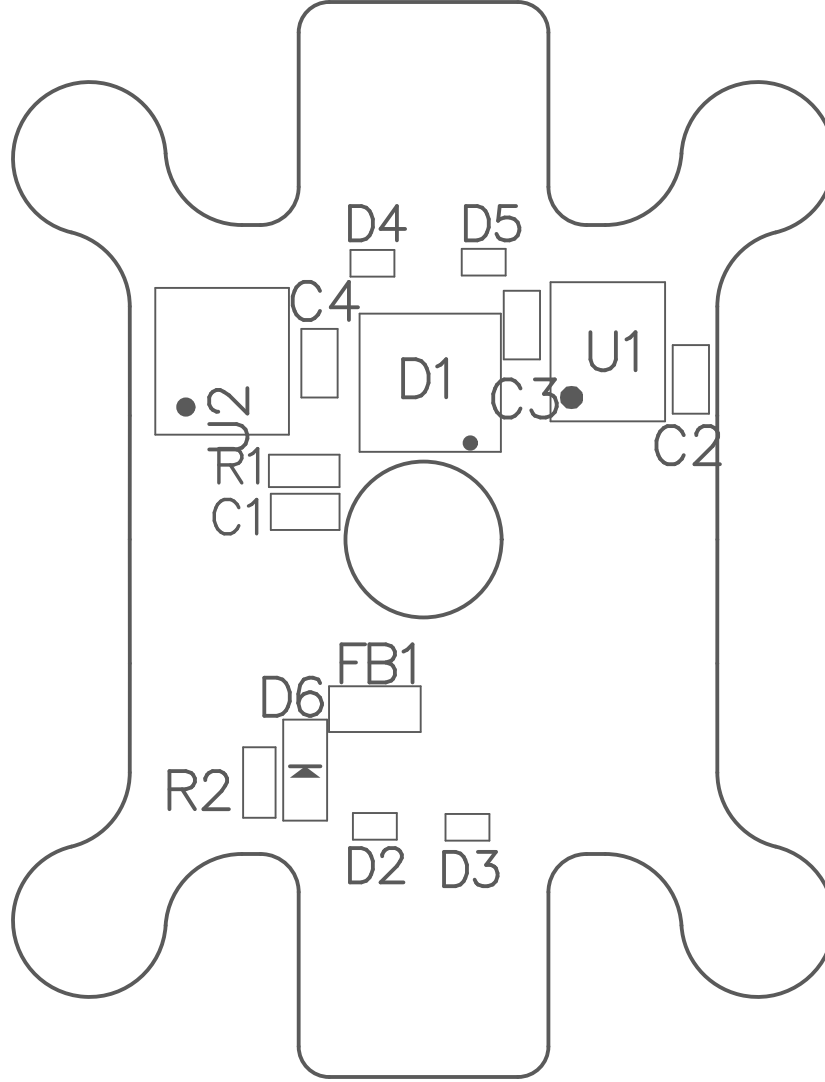
This information is provided "as-is". You bear the risk of using it. Some information relates to pre-released specification which may change without notice. Microsoft makes no warranties, express or implied, with respect to the information provided here.

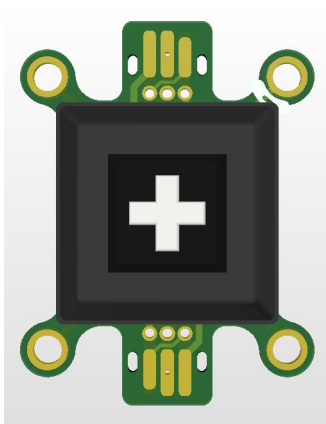
Board Outline
Top Assy

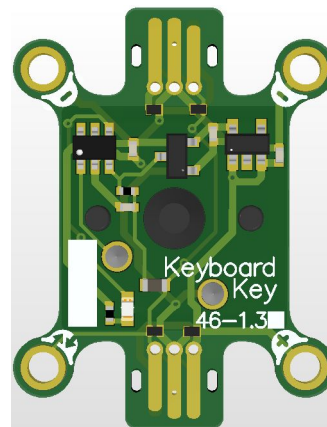


Board Outline

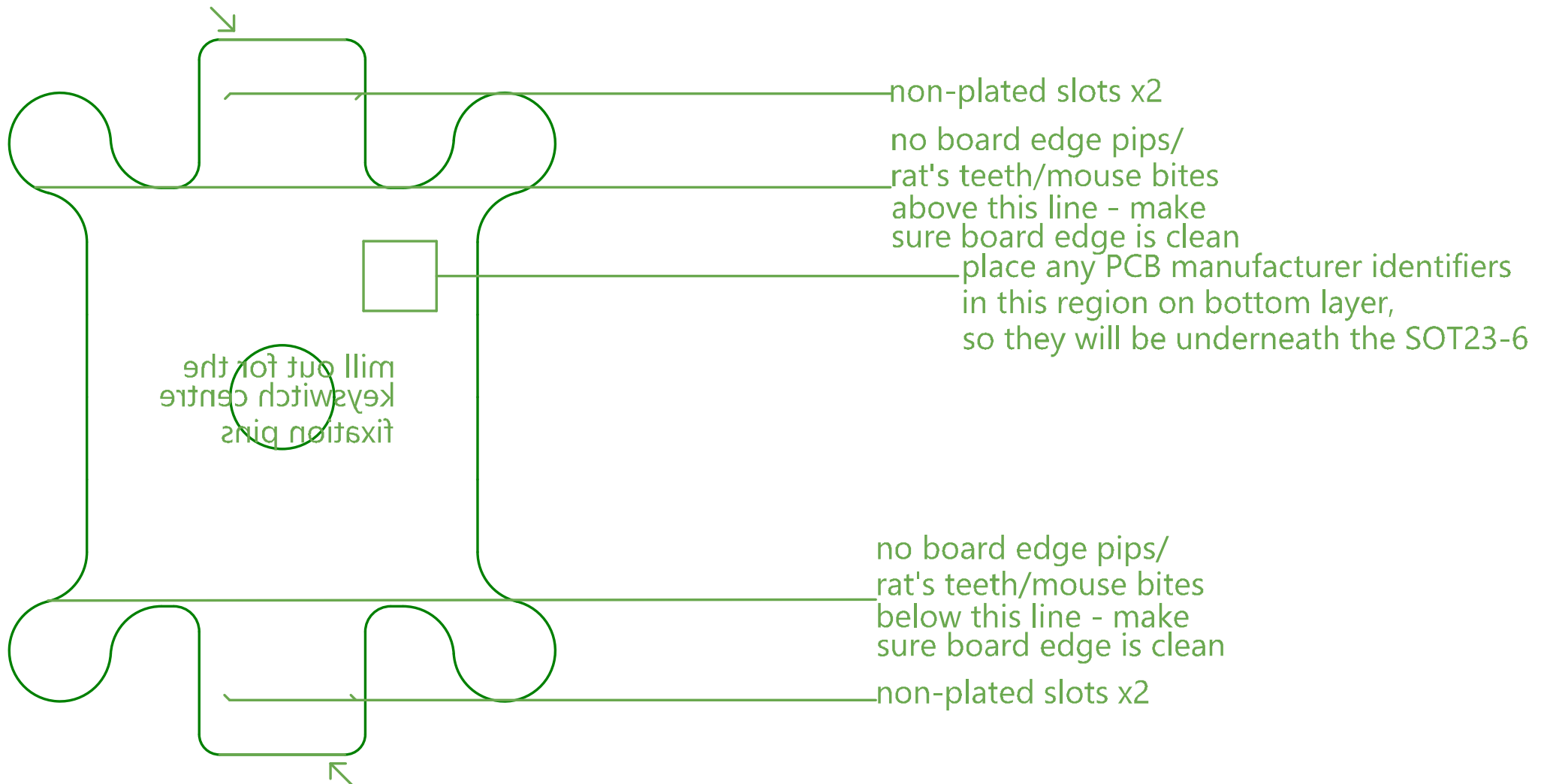
Bottom Assy





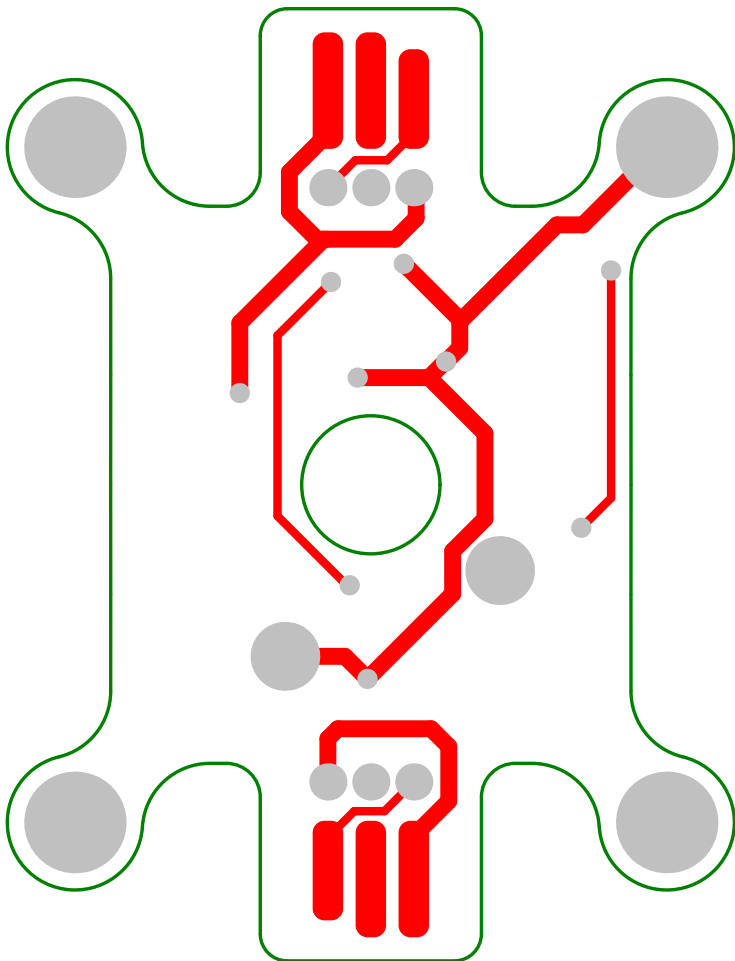


Fabrication Notes Board Outline



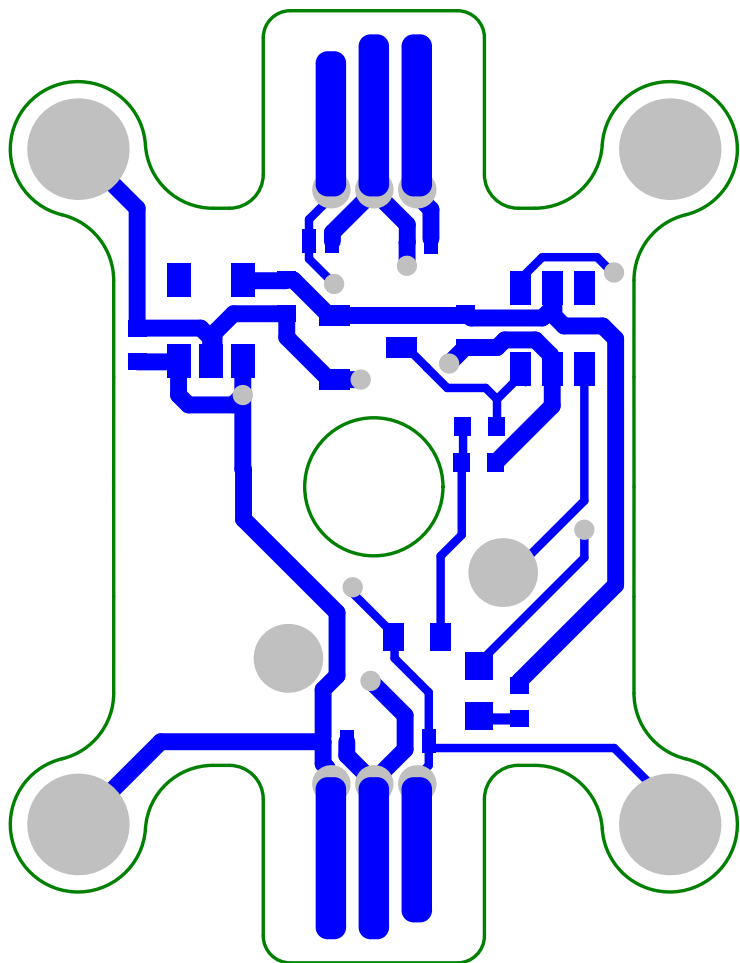
Top Layer

Board Outline



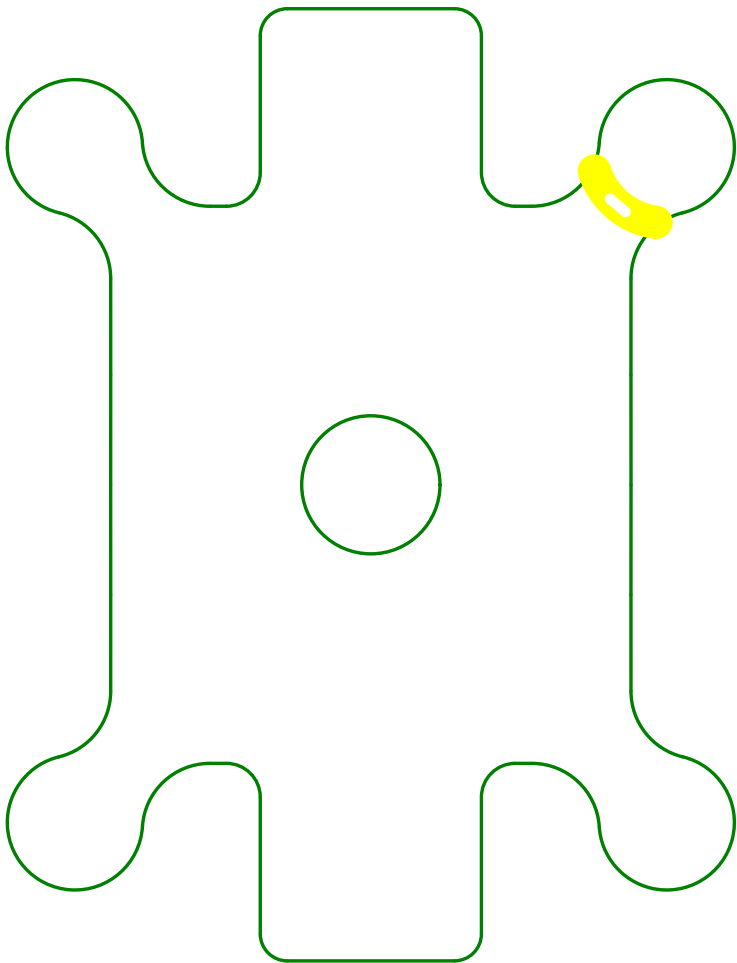
Bottom Layer

Board Outline



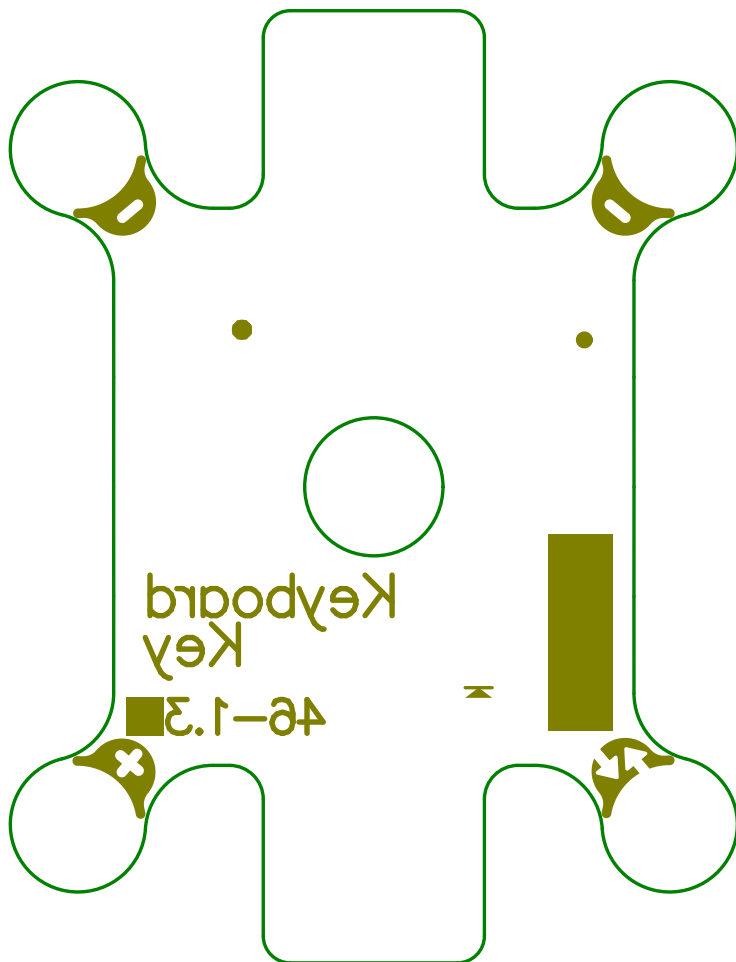
Board Outline

Top Overlay



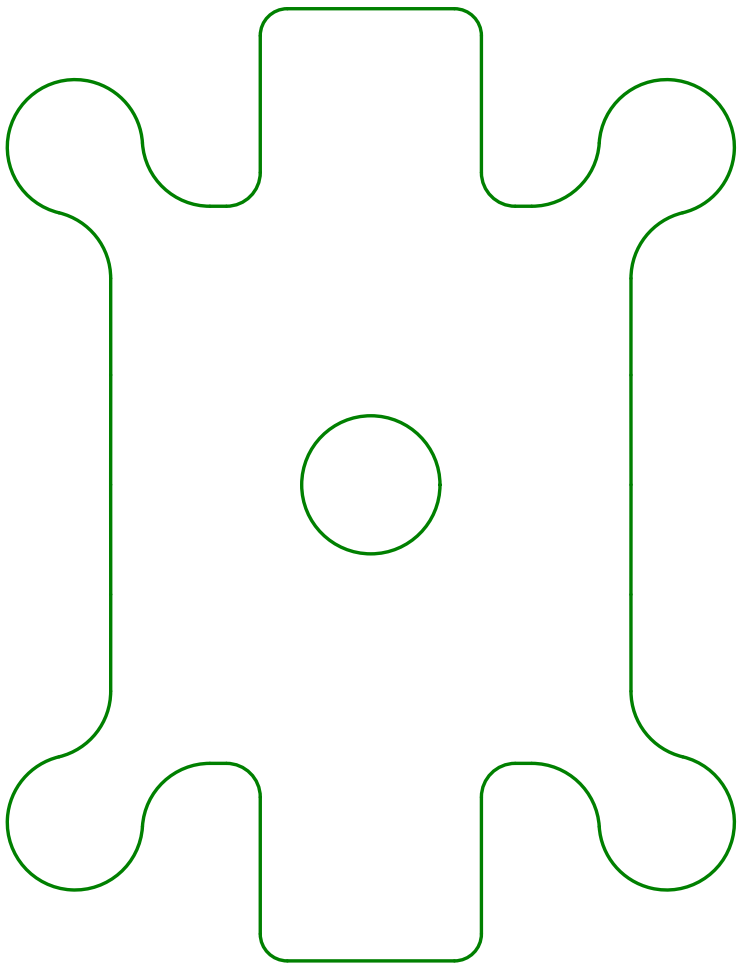
Board Outline

Bottom Overlay



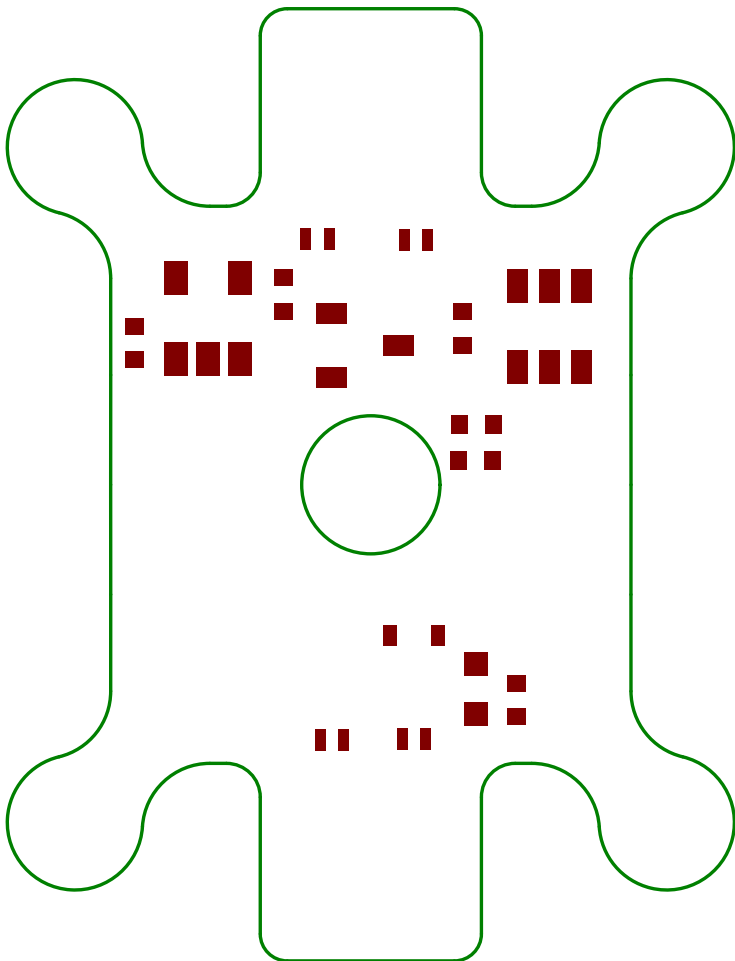
Board Outline

Top Paste



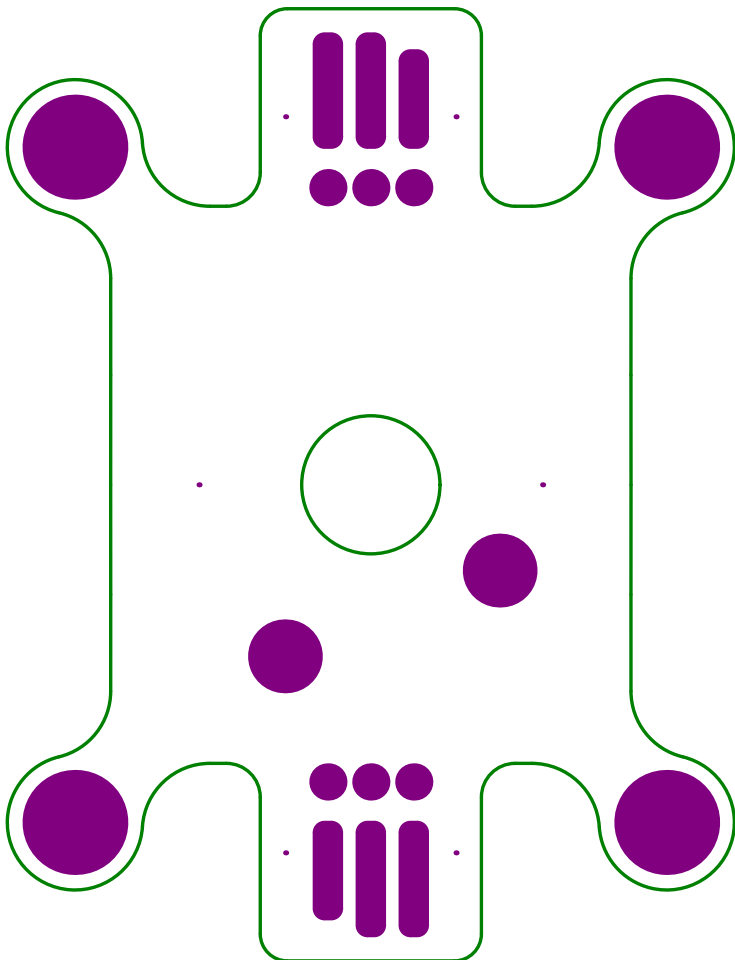
Board Outline

Bottom Paste



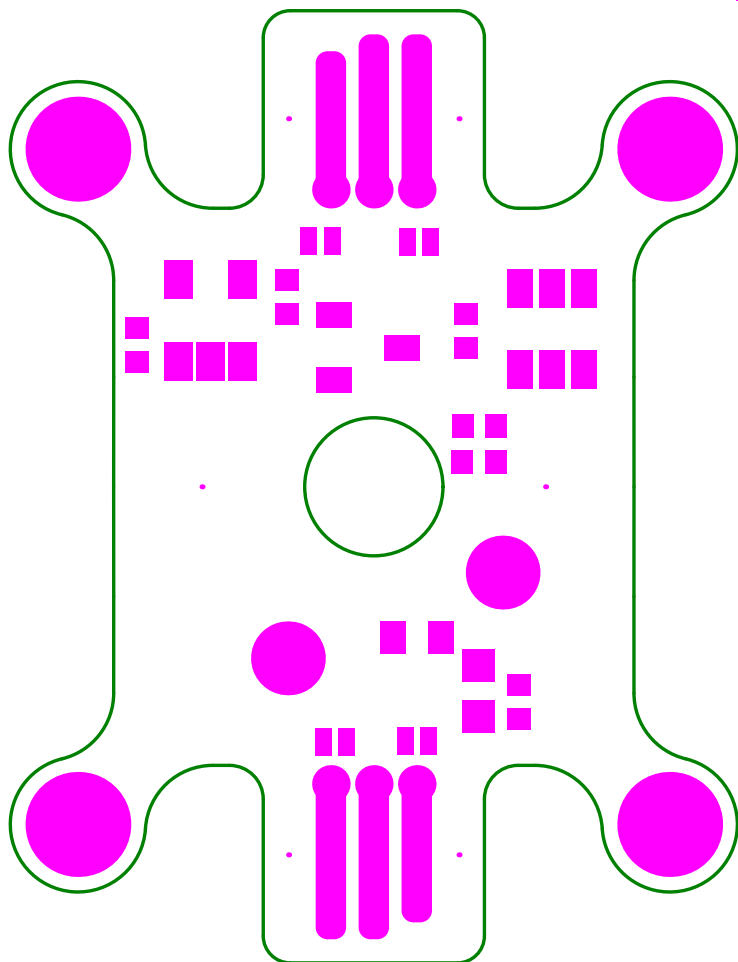
Board Outline

Top Solder (resist)



Board Outline

Bottom Solder (resist)



Board Outline

